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FQPF9N25C / FQPF9N25CT

N-Channel QFET® MOSFET

250 V, 8.8 A, 430 mΩ

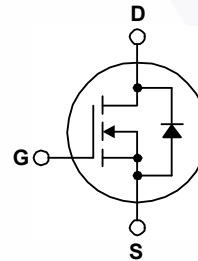
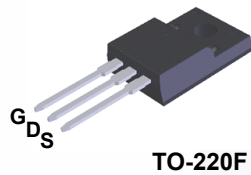
Features

- 8.8 A, 250 V, $R_{DS(on)} = 430 \text{ m}\Omega$ (Max.) @ $V_{GS} = 10 \text{ V}$, $I_D = 4.4 \text{ A}$
- Low Gate Charge (Typ. 26.5 nC)
- Low Crss (Typ. 45.5 pF)
- 100% Avalanche Tested

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, DC-AC converters for uninterrupted power supplies and motor controls.



MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | FQPF9N25C / FQPF9N25CT | Unit |
|----------------|--|--|------------------|
| V_{DSS} | Drain to Source Voltage | 250 | V |
| I_D | Drain Current | - Continuous ($T_C = 25^\circ\text{C}$) | 8.8 * |
| | | - Continuous ($T_C = 100^\circ\text{C}$) | 5.6 * |
| I_{DM} | Drain Current | - Pulsed (Note 1) | 35.2 * |
| V_{GSS} | Gate to Source Voltage | ± 30 | V |
| E_{AS} | Single Pulsed Avalanche Energy | (Note 2) | 285 |
| I_{AR} | Avalanche Current | (Note 1) | 8.8 |
| E_{AR} | Repetitive Avalanche Energy | (Note 1) | 7.4 |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | 5.5 |
| P_D | Power Dissipation | ($T_C = 25^\circ\text{C}$) | 38 |
| | | - Derate Above 25°C | 0.3 |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds | 300 | $^\circ\text{C}$ |

*Drain current limited by maximum junction temperature

Thermal Characteristics

| Symbol | Parameter | FQPF9N25C / FQPF9N25CT | Unit |
|-----------------|---|------------------------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 3.29 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5 | |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|------------|---------|-----------|------------|----------|
| FQPF9N25C | FQPF9N25C | TO-220F | Tube | N/A | 50 units |
| FQPF9N25CT | FQPF9N25CT | TO-220F | Tube | N/A | 50 units |

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---|---|---|----------|------|------|---------------------------|
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$ | 250 | -- | -- | V |
| $\Delta BV_{DSS} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D = 250\ \mu\text{A}$, Referenced to 25°C | -- | 0.30 | -- | $\text{V}/^\circ\text{C}$ |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 250\text{ V}, V_{GS} = 0\text{ V}$ | -- | -- | 10 | μA |
| | | $V_{DS} = 200\text{ V}, T_C = 125^\circ\text{C}$ | -- | -- | 100 | μA |
| I_{GSSF} | Gate-Body Leakage Current, Forward | $V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$ | -- | -- | 100 | nA |
| I_{GSSR} | Gate-Body Leakage Current, Reverse | $V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$ | -- | -- | -100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$ | 2.0 | -- | 4.0 | V |
| $R_{DS(on)}$ | Static Drain-Source On-Resistance | $V_{GS} = 10\text{ V}, I_D = 4.4\text{ A}$ | -- | 0.35 | 0.43 | Ω |
| g_{FS} | Forward Transconductance | $V_{DS} = 40\text{ V}, I_D = 4.4\text{ A}$ | -- | 7.0 | -- | S |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}, f = 1.0\text{ MHz}$ | -- | 545 | 710 | pF |
| C_{oss} | Output Capacitance | | -- | 115 | 150 | pF |
| C_{rss} | Reverse Transfer Capacitance | | -- | 45.5 | 60 | pF |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD} = 125\text{ V}, I_D = 8.8\text{ A}, V_{GS} = 10\text{ V}, R_G = 25\ \Omega$ | -- | 15 | 40 | ns |
| t_r | Turn-On Rise Time | | -- | 85 | 180 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | -- | 90 | 190 | ns |
| t_f | Turn-Off Fall Time | | (Note 4) | -- | 65 | 140 |
| Q_g | Total Gate Charge | $V_{DS} = 200\text{ V}, I_D = 8.8\text{ A}, V_{GS} = 10\text{ V}$ | -- | 26.5 | 35 | nC |
| Q_{gs} | Gate-Source Charge | | -- | 3.5 | -- | nC |
| Q_{gd} | Gate-Drain Charge | | (Note 4) | -- | 13.5 | -- |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_S | Maximum Continuous Drain-Source Diode Forward Current | | -- | -- | 8.8 | A |
| I_{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | -- | -- | 35.2 | A |
| V_{SD} | Drain-Source Diode Forward Voltage | $V_{GS} = 0\text{ V}, I_S = 8.8\text{ A}$ | -- | -- | 1.5 | V |
| t_{rr} | Reverse Recovery Time | $V_{GS} = 0\text{ V}, I_S = 8.8\text{ A}, di_F / dt = 100\text{ A}/\mu\text{s}$ | -- | 218 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | | -- | 1.58 | -- | μC |

Notes:

1. Repetitive rating : pulse-width limited by maximum junction temperature.
2. $L = 5.9\text{ mH}, I_{AS} = 8.8\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\ \Omega$, starting $T_J = 25^\circ\text{C}$.
3. $I_{SD} \leq 8.8\text{ A}, di/dt \leq 300\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$, starting $T_J = 25^\circ\text{C}$.
4. Essentially independent of operating temperature.

Typical Characteristics

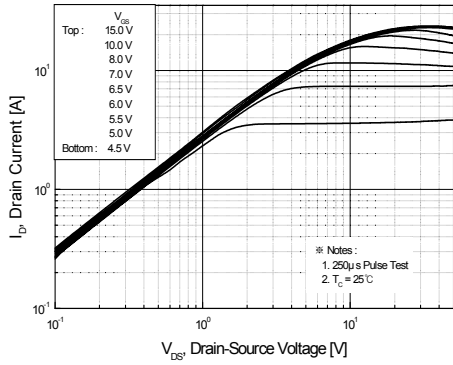


Figure 1. On-Region Characteristics

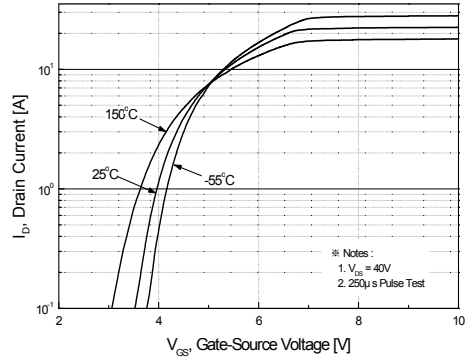


Figure 2. Transfer Characteristics

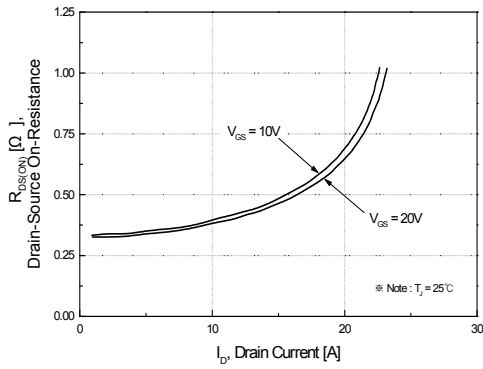


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

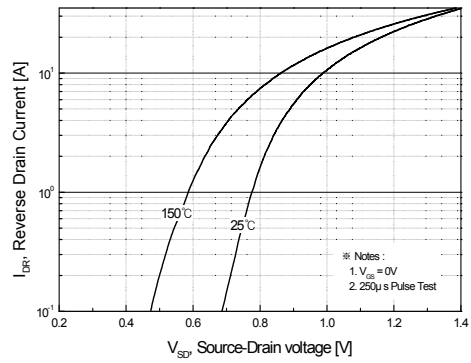


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

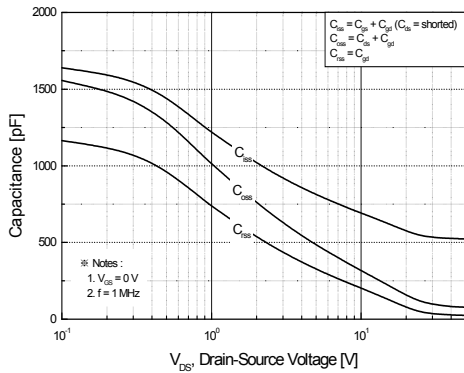


Figure 5. Capacitance Characteristics

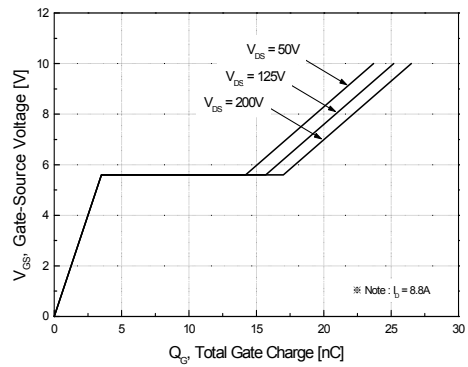


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

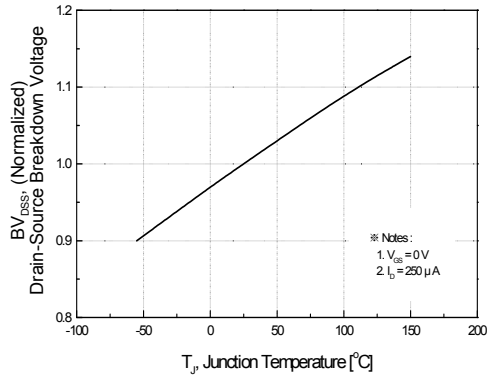


Figure 7. Breakdown Voltage Variation vs Temperature

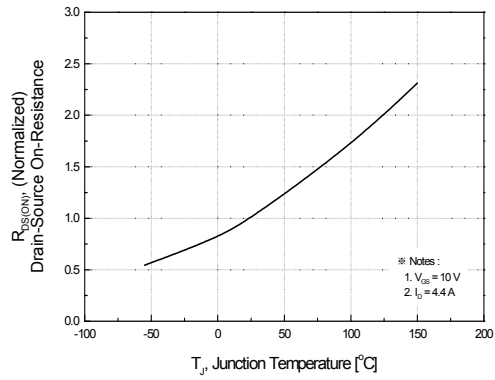


Figure 8. On-Resistance Variation vs Temperature

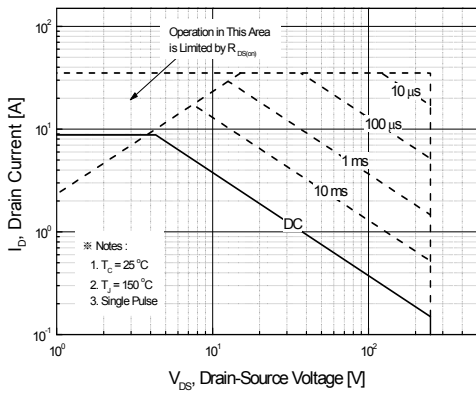


Figure 9. Maximum Safe Operating Area

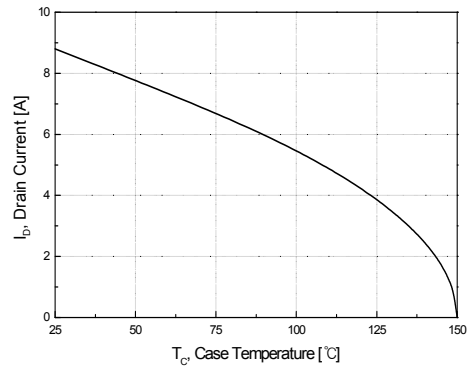


Figure 10. Maximum Drain Current vs Case Temperature

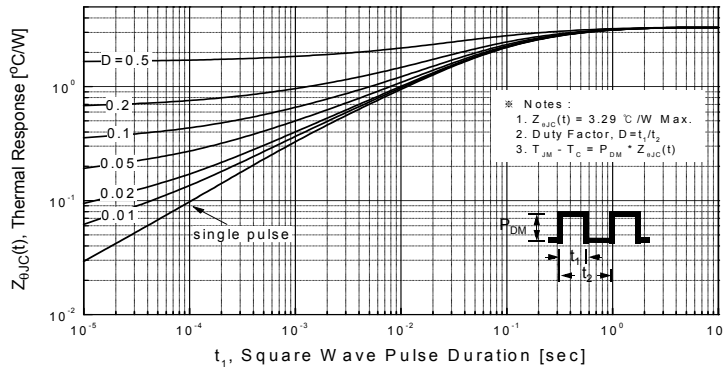


Figure 11. Transient Thermal Response Curve

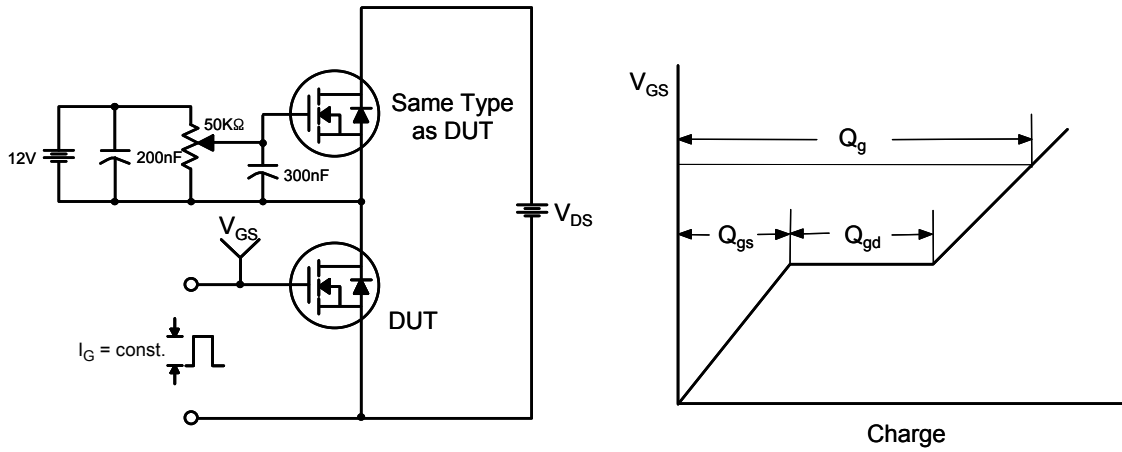


Figure 12. Gate Charge Test Circuit & Waveform

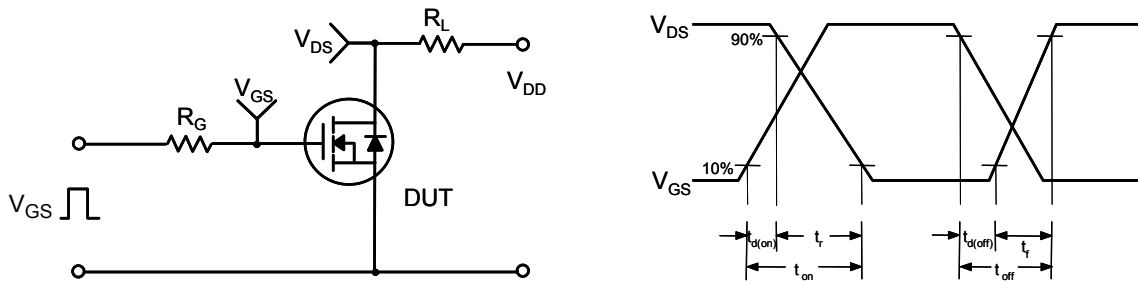


Figure 13. Resistive Switching Test Circuit & Waveforms

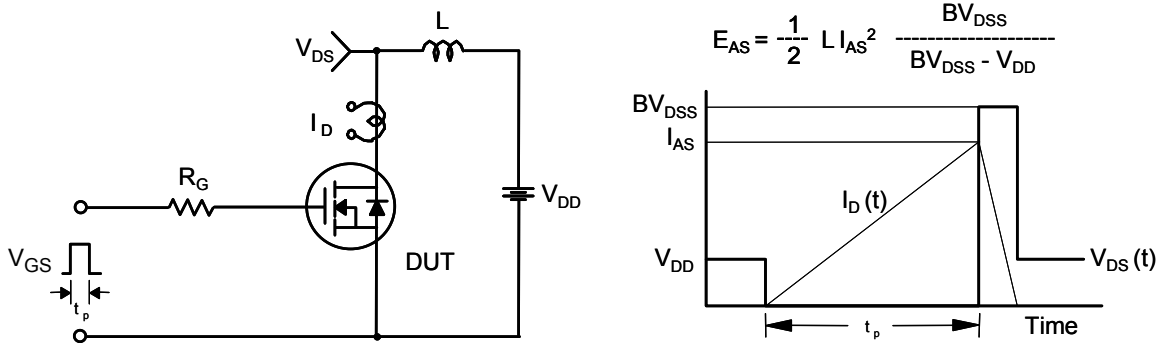


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

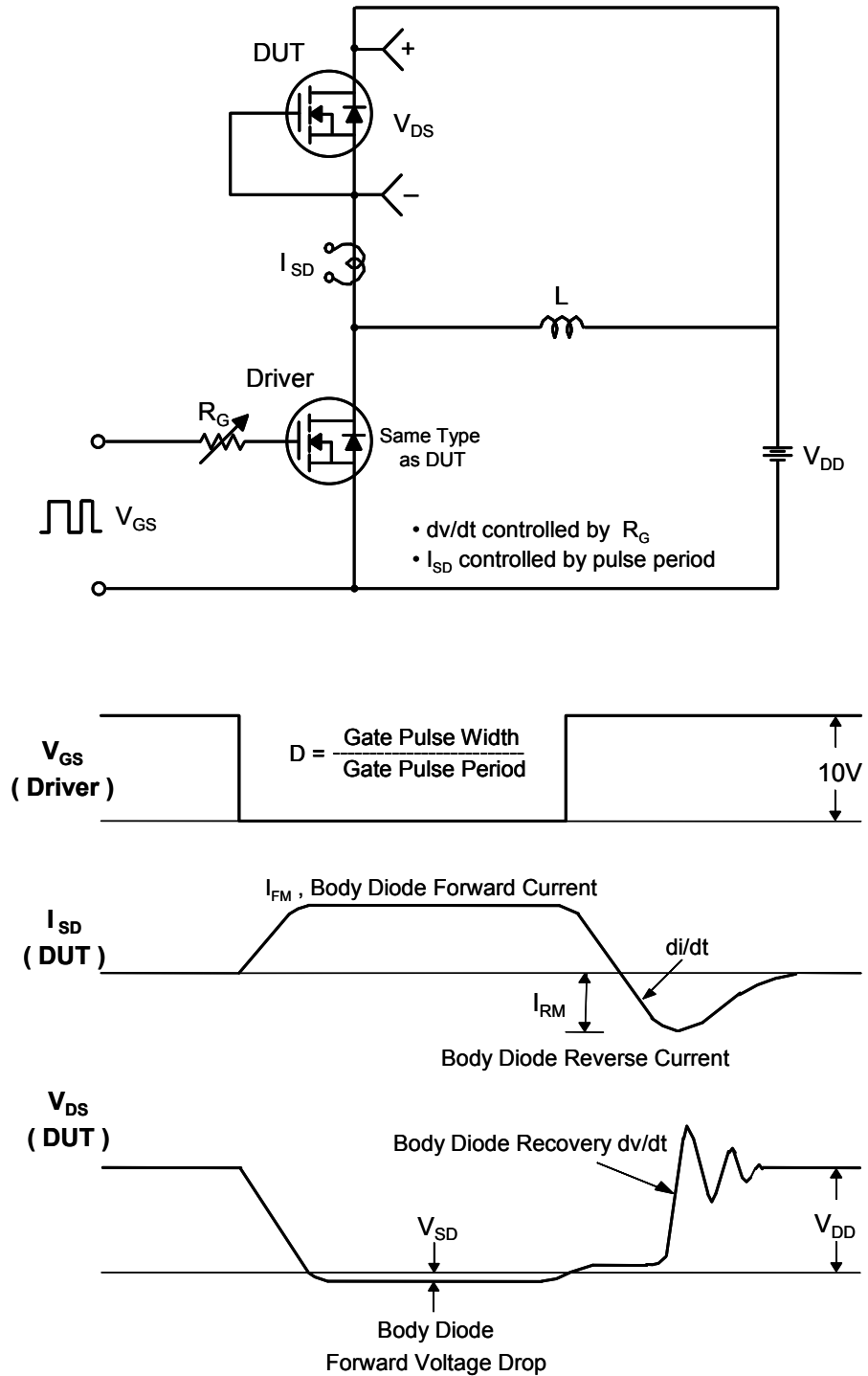


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions



NOTES:

- A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A.
- B. DOES NOT COMPLY EIAJ STD. VALUE.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- F. OPTION 1 - WITH SUPPORT PIN HOLE.
OPTION 2 - NO SUPPORT PIN HOLE.
- G. DRAWING FILE NAME: TO220M03REV3

Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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